-	0	((solid near state) and (optical$5 near pump$4) and (heat near sink)) and (adhesive with (cross near linked))	USPAT	2003/07/25 09:54
-	238	(solid near state) and (optical$5 near pump$4) and (heat near sink)	USPAT	2003/07/25 10:01
-	209	((solid near state) and (optical$5 near pump$4) and (heat near sink)) and 372/$.ccls.	USPAT	2003/07/25 09:59
-	190	(solid near state near laser) and (optical$5 near pump$4) and (heat near sink) and 372/$.ccls.	USPAT	2003/07/25 10:21
-	81	(solid near state near laser) and (optical$5 near pump$4) and (heat near sink) and 372/$.ccls. and amplif$5	USPAT	2003/07/25 10:23
-	0	(solid near state near2 host near2 crystal)and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 10:12
-	0	(solid near state near2 host near2 crystal) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 10:12
-	69	(solid near state) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 10:13
-	2	(solid near state near3 crystal) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 09:26

L Number	Hits	Search Text	DB	Time stamp
30	1	(solid near state near3 crystal) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser and (adhesive near (layer or film or medium or region)) and flat	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 09:43
31	1	(solid near state near3 crystal) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and (pump$4 or laser) and (adhesive near (layer or film or medium or region)) and flat	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 09:48
32	2	(solid near state near3 crystal) and active and amplif$5 and (cool$4 or heatsink or (heat near sink)) and (pump$4 or laser) and (adhesive near (layer or film or medium or region)) and (surface or flat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 09:51
33	2	(solid near state near3 crystal) and active and amplif$5 and (cool$4 or heatsink or (heat near sink)) and (pump$4 or laser) and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 10:42
37	6	(solid near state near3 crystal) and active and (cool$4 or heatsink or (heat near sink)) and (pump$4 or laser) and (adhesive near (layer or film or medium or region))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/19 10:43
-	1002	(solid near state) and active and amplif$5 and cool$4 and thermal$5 and heat$4 and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 10:11
-	391	(solid near state) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/02 16:59
-	251	((solid near state) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4) and 372/$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/02 17:01
-	259	(solid near state near laser) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/02 17:01
-	199	((solid near state near laser) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4) and 372/$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/03 10:00
-	154	((solid near state near laser) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4) and liquid and solid and material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/03 10:03
-	244	((solid near state) and active and (laser with amplif$5) and cool$4 and thermal$5 and heat$4) and liquid and solid and material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/03 10:29

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